

Photosensitivity of Amorphous InGaZnO Thin-Film Transistors

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Over the last several years, there has been a great interest in thin-film transistors (TFT) made of transparent amorphous InGaZnO₄ (a-IGZO) semiconductors. This is mainly due to its unique advantages such as visible light transparency, large-area uniform deposition at low temperature, and high carrier mobility. These attractive properties can potentially overcome all the drawbacks currently existing in conventional amorphous or polycrystalline silicon TFT used for active-matrix flat-panel displays (AM-FPDs). In this project, we studied the photosensitivity of a-IGZO TFT and evaluated its feasibility to AM-FPDs.

We have fabricated inverted staggered a-IGZO TFTs and measured their electrical properties under monochromatic illumination. With the illumination wavelengths ranging from 460nm to 660nm, the TFT off-state drain current only slightly increases, while a large increase was observed for the wavelength below 400nm.

Threshold voltage and sub-threshold swing are also only slightly modified between 460nm to 660nm, while field-effect mobility is unchanged in the investigated photo-energy range. The results are consistent with the a-IGZO optical energy band gap of about 3.05eV. Our study suggests that the a-IGZO TFTs are light sensitive only above 3.0eV and

is suitable for a stable operation in AM-FPDs. This project is partially supported by the Defense Advanced Research Projects Agency and Applied Materials, Inc.

